

Product Compliance Declaration

Please see www.molex.com for the most up-to-date information.

Contact Information

Name Molex Product Compliance E-Mail Product.Compliance@molex.com

Part Information

Part Name "CGrid SL IDT Opt G 15""SAu 4Ckt"

Product Composition

Name	Туре	CAS Number	Proportion (% Total)	Mass (Grams)	
"CGrid SL IDT Opt G 15""SAu 4Ckt"	Assembly		100	0.763844	
SL Female IDT Term 15"SAu Formed	Assembly		42.9203	0.327844	
SL Female IDT Term 15"SAu	Assembly		42.9203	0.327844	
SL Term Blanked	Component		40.3224	0.308	
Phosphor Bronze 5% Unplated	Material		40.3224	0.308	
Copper	Substance	7440-50-8	38.2458	0.292138	
Tin	Substance	7440-31-5	2.0161	0.0154	
Phosphorus	Substance	7723-14-0	0.0605	0.000462	
Gold Plating	Material		0.0319	0.000244	
Cobalt	Substance	7440-48-4	8E-05	6E-07	
Nickel	Substance	7440-02-0	8E-05	6E-07	
Gold	Substance	7440-57-5	0.0317	0.000242	
Nickel Plating	Material		1.2568	0.0096	

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Name	Туре	CAS Number	Proportion (% Total)	Mass (Grams)
Nickel	Substance	7440-02-0	1.2567	0.009599
Further Additives, not to declare	Substance	system	0.0001	1E-06
Tin Plating	Material		1.3092	0.01
Tin	Substance	7440-31-5	1.3092	0.01
SL Crp Hsg G SR Pos Ltch 4Ckt	Component		57.0797	0.436
PBT+PC GF BLACK	Material		57.0797	0.436
PC+PBT	Substance		29.7311	0.227099
GF-Fibre	Substance		18.8611	0.14407
Flame Retardant, ISO 1043-4 FR(17)	Substance		5.2613	0.040188
Antimonytrioxide	Substance	1309-64-4	1.8365	0.014028
Pigment portion, not to declare	Substance	system	0.6949	0.005308
Further Additives, not to declare	Substance	system	0.6949	0.005308

ROHS Declaration Information

Regulatory Revision EU 2015/863

Compliance Status Compliant

Contained Substances Exceeding Threshold

None

Exemptions

None

REACH-SVHC Declaration Information

Regulatory Revision D(2020)4578-DC (25 June 2020)

Contained Substances Exceeding Threshold

None

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GADSL Declaration Information

Regulatory Revision GADSL imported from IMDS

Contained Substances Exceeding Threshold

Substance Group	Substance Location	Threshold (PPM)	Concentration (PPM)	Intentionally Added		
lead	e-plate Sn (electrodeposited Tin Coatings, bright and matt) *Note 500		500	Yes		
lead	Phosphor Bronze 5% A (CA510)	*Note	*Note 250		250 Yes	
Antimonytrioxide	PBT+PC GF BLACK	*Note	40,000	Yes		
nickel powder [particle diameter < 1 mm]	e-plate Au (Hardgold) (electrodeposited Hardgold	*Note	2,500	Yes		
nickel powder [particle diameter < 1 mm]	Ep-Ni	*Note	997,500	Yes		
Cobalt	e-plate Au (Hardgold) (electrodeposited Hardgold	*Note	2,500	Yes		
copper	Phosphor Bronze 5% A (CA510) *Note 943,350		943,350	Yes		
glass, oxide, chemicals	PBT+PC GF BLACK	*Note	350,000	Yes		

^{*}Note: For GADSL substance declarable/prohibited threshold values, please reference http://www.gadsl.org/

Exemptions

Part Name	Exemption		
e-plate Sn (electrodeposited Tin Coatings, bright and matt)	44 Concentration within acceptable GADSL limits		
Phosphor Bronze 5% A (CA510)	44 Concentration within acceptable GADSL limits		
e-plate Au (Hardgold) (electrodeposited Hardgold Coatings)	34 Not applicable		
Ep-Ni	33 Other application (Surface not routinely touched or nickel release rate < 0.5µg/cm2/week)		

HFLH Declaration Information

Regulatory Revision IEC 61249-2-21

Contained Substances Exceeding Threshold

Substance Group	Substance Location	Threshold (PPM)	Concentration (PPM)	Intentionally Added
Bromine and its compounds	PBT+PC GF BLACK	900	100,000	Yes
Bromine and Chlorine combined	PBT+PC GF BLACK	1,500	100,000	Yes

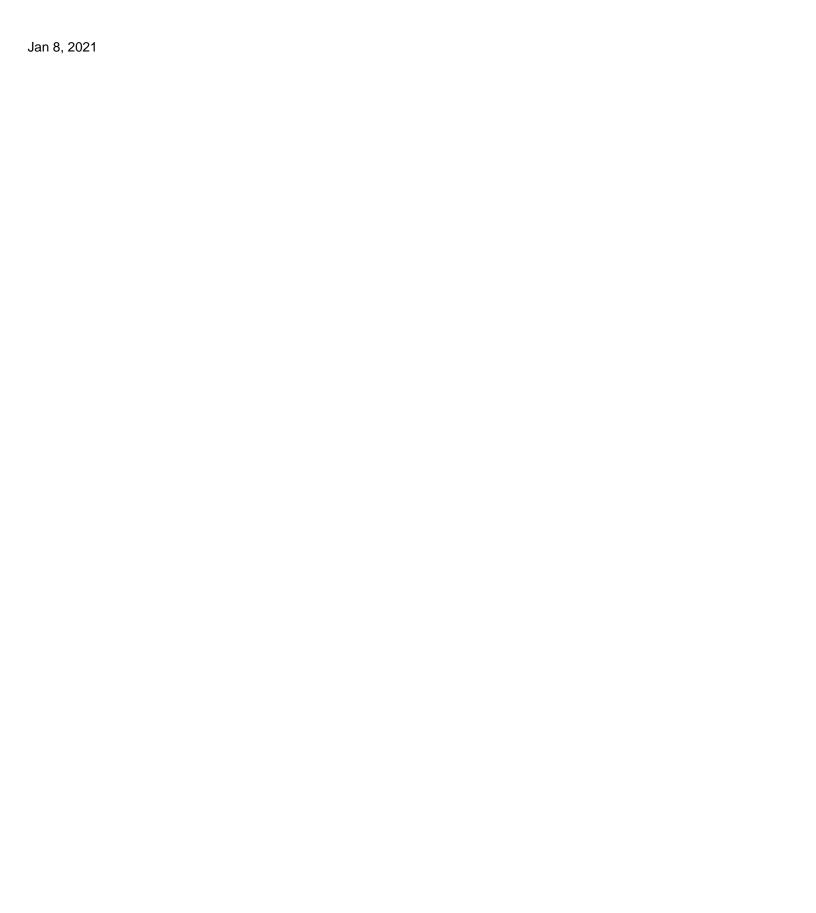
China ROHS Declaration Information

Part Number 0014562042							
Part Name "CGrid SL IDT Opt G 15""SAu 4Ckt"	(e)						
Part Information			Haz	zardous S	Substance	es	
Components		Lead	Mercury	Cadmium	Hex. Chromium	PBB	PBDE
"CGrid SL IDT Opt G 15""SAu 4Ckt"		0	0	0	0	0	0
SL Female IDT Term 15"SAu Formed		0	0	0	0	0	0
SL Female IDT Term 15"SAu		0	0	0	0	0	0
SL Term Blanked		0	0	0	0	0	0
SL Crp Hsg G SR Pos Ltch 4Ckt		0	0	0	0	0	0

Process Information

Component Plating / Surface Finish	N/A
Termination Base Alloy	P-Bronze
Solder Alloy	N/A
Process Capability	N/A
Maximum Exposure Time (seconds)	N/A
Maximum Process Temperature (C)	N/A
Maximum Cycles at Reflow Temperature	N/A
J-STD-020 Moisture Sensitivity Level	N/A

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